

### SMART QUAD SWITCH

- Modified VDMOS Power Stage (U<sub>DSBR</sub> > 80V)
- RDSON < 500 mOhm ( $T_i = 25$ °C)
- CMOS Compatible Inputs
- Enable Input (Reset)
- Outputs Capable of up to 2.2 Amperes
- Outputs Internally Clamped at 70V for Fast Inductive Load Switch Off
- Wide operating supply voltage from 4.7V up to 30V
- DIAGNOSTIC FUNCTIONS
- Open Load Detection (Output off, 100µsfiltering time)
- Short to Ground Detection (Output off, 100μs filtering time)
- Short to Battery Detection (Output on)
- Over temperature detection (Output on)
- Storage of last fault in 8 Bit Serial Register
- Fault Signal Indication at Serial Data Out without need to read out the Serial Interface
- Daisy Chainable Serial Diagnostic

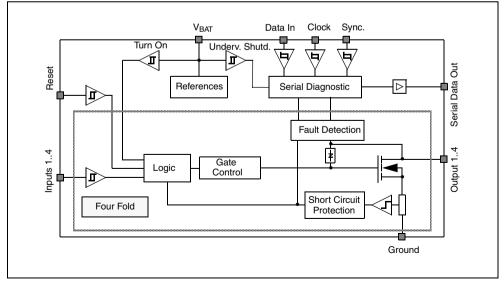


■ Serial Interface Clock Frequency up to 500kHz

#### DESCRIPTION

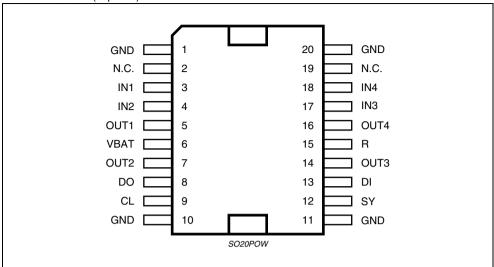
The L9651 consists of four identical low side power switches. A serial diagnostic interface indicates failure mode of each switch (short circuit to  $V_{BAT}$  or ground and open load or over temperature).

#### **BLOCK DIAGRAM**



September 2013

# PIN CONNECTION (Top view)



#### **PIN FUNCTION**

. In the tier						
N°	Pin	Function				
1, 10, 11, 20	GND	Ground				
2, 19	N.C.	Not Connected				
3	IN1	Input 1				
4	IN2	Input 2				
5	OUT1	Output 1				
6	VBAT	Supply Voltage				
7	OUT2	Output 2				
8	DO	Serial Data Out				
9	CL	Clock				
12	SY	Synchronization				
13	DI	Serial Data In				
14	OUT3	Output 3				
15	R	Reset				
16	OUT4	Output 4				
17	IN3	Input 3				
18	IN4	Input 4				

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#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
T <sub>STG</sub>	Storage Temperature	-55 to 150	°C
TJ	Operating Junction Temperature	-40 to 150	°C
$V_{BAT}$	DC Supply Voltage	-2 to 30	V
V <sub>BATtr</sub>	Transient Supply Voltage; t < 400ms	40	V
Vout	Output Voltage	65	V
V <sub>OUTtr</sub>	Transient Output Voltage; during clamping	78	V
Ecl	Output Clamping energy; repetition rate < 100 Hz	10	mJ
-lout	Output reverse current	2	Α
V <sub>R</sub> ,V <sub>INi</sub> ,V <sub>DI,</sub> V <sub>CL</sub> V <sub>SY</sub>	Control Input voltage	-0.3 to 6.5	V
V <sub>DO</sub>	Control Output voltage	-0.3 to 6.5	V

# THERMAL DATA

Symbol	Parameter	Value	Unit
R <sub>th j-case</sub>	Thermal Resistance Junction to Case	2.5	°C/W

# ELECTRICAL CHARACTERISTCS (6.5V < V<sub>BAT</sub> < 25V, -40 < T<sub>J</sub> < 150°C)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit		
Supply Voltage								
V <sub>BATU</sub>	Turn on threshold voltage		2.0		4.7	V		
I <sub>BAT</sub>	Supply current	V <sub>BAT</sub> = 14V V <sub>OUTi</sub> > 0V	4	10	15	mA		
Output st	tage				•			
R <sub>DSON</sub>	On resistance	V <sub>BAT</sub> = 14V T <sub>J</sub> = 25°C; I <sub>out</sub> = 1A			500	mΩ		
		V <sub>BAT</sub> = 14V T <sub>J</sub> = 150°C; I <sub>out</sub> = 1A			850	mΩ		
V <sub>CL</sub>	Clamping voltage, inductive load	l <sub>out</sub> = 0.5 A	63	70	76	V		
l <sub>OUTi</sub>	Over current shutdown	T <sub>J</sub> = -40°C	3.0		4.3	Α		
	(Shutdown latch resets with pos. slope at INi)	T <sub>J</sub> = 25°C	2.5		3.7	Α		
		T <sub>J</sub> = 150°C	2.2		3.5	Α		
Output leakage current see: Open load diagnostic current								

# **ELECTRICAL CHARACTERISTCS** (continued)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit		
Logic Inputs IN1IN4, SY, CL, DI, R								
VINILH VSYLH VCLLH VRLH VDILH	Input High level		3.5		6.5	V		
VINIHL VSYHL VCLHL VRHL VDIHL	Input Low level		-0.3		1.5	V		
V <sub>INih</sub> V <sub>SYh</sub> V <sub>CLh</sub> V <sub>Rh</sub> V <sub>Dlh</sub>	Hysteresis		0.2		1	V		
- I <sub>INi</sub>	Input current IN1 IN4, SY, CL, R (Internal pull up current source)	V <sub>INi</sub> = 0V	10	40	120	μА		
- I <sub>SY</sub> - I <sub>C L</sub> - I <sub>R</sub>	(linerial pull up current source)	$\begin{aligned} &V_{SY} = 0V \\ &V_{CL} = 0V \\ &V_{R} = 0V \end{aligned}$	10		80			
- I <sub>DI</sub>	Input current DI (Internal pull up current source)	$V_{DI} = 0V$	120	220	250	μΑ		
Timing								
t <sub>don</sub>	Turn on delay			7.5		μS		
t <sub>doff</sub>	Turn off delay			7.5		μS		
Son	Switch on slew rate			10		V/μs		
S <sub>off</sub>	Switch off slew rate			15		V/μs		
t <sub>oc</sub>	Over current detection time			0.5		μS		
t <sub>v</sub>	Open load filtering time		60	100	200	μS		
t <sub>v</sub>	Short to GND filtering time		60	100	200	μS		
f <sub>CL</sub>	Serial clock frequency		0		500	kHz		
t <sub>vDV</sub>	DO: Datavalidtime		0.03		1	μS		
t <sub>vset</sub>	DI: Datasettlingtime		0.5			μS		
t <sub>vhold</sub>	DI: Dataholdtime		0			μS		
Diagnost	ic	•	•					
V <sub>BATDU</sub>	Under voltage threshold		4.7		7.5	٧		
Serial Data output (External pull up required)								
V <sub>DO</sub>	Data output low voltage	I <sub>DO</sub> < 1.6mA 7.5V < V <sub>BAT</sub> < 22V	0		0.45	V		
I I <sub>DO</sub> I	Data output leakage current				10	μА		

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#### **ELECTRICAL CHARACTERISTCS** (continued)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit			
Output vo	Output voltage monitoring Output off								
V <sub>OL</sub>	Open load threshold voltage (fault detected if V <sub>OUTi</sub> < V <sub>OL</sub> )	7.5V < V <sub>BAT</sub> < 22V		2/3V <sub>BAT</sub>					
V <sub>SG</sub>	Short to GND threshold voltage (fault detected if $V_{OUTi} < V_{SG}$ )	7.5V < V <sub>BAT</sub> < 22V		1/3V <sub>BAT</sub>					
Open load	I diagnostic current Output off		•						
	Open load output voltage	I <sub>OUT</sub> = 0 A V <sub>INi</sub> = 5V 7.5V < V <sub>BAT</sub> < 22V		1/2V <sub>BAT</sub>					
- I <sub>OUTi</sub>	Output current	V <sub>OUT</sub> = 1V V <sub>INi</sub> = 5V	50	100	150	μА			
Іоиті	Output current	V <sub>OUT</sub> = V <sub>BAT</sub> V <sub>INi</sub> = 5V 7.5V < V <sub>BAT</sub> < 22V	200	320	500	μА			
Overload	Diagnostic								
	Over temperature diagnostic	TJ		175		°C			
Іоиті	Over current	T <sub>J</sub> = -40°C	3.0		4.3	Α			
		T <sub>J</sub> = 25°C	2.5		3.7	Α			
		T <sub>J</sub> = 150°C	2.2		3.5	Α			

Figure 1. Typical Timing Diagram for Serial Diagnostic

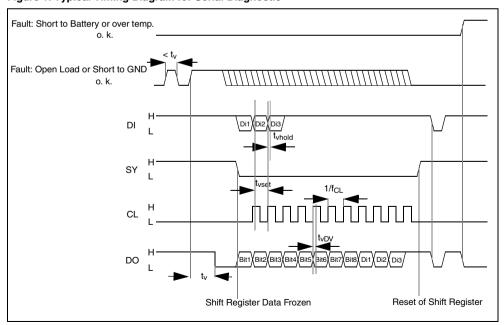


Figure 2. Serial Interface Error Coding

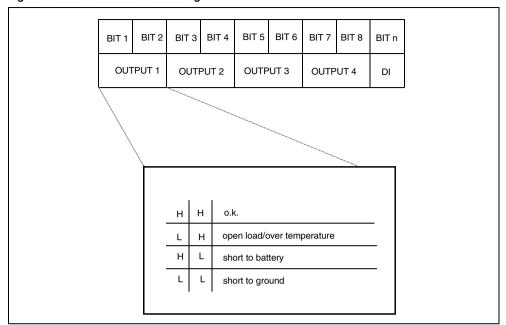
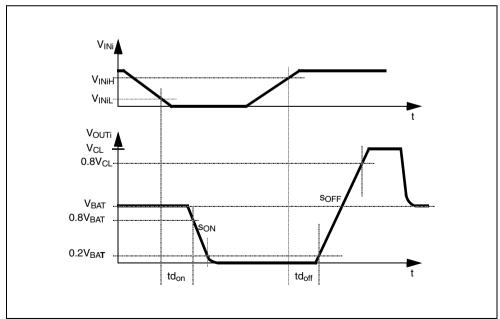
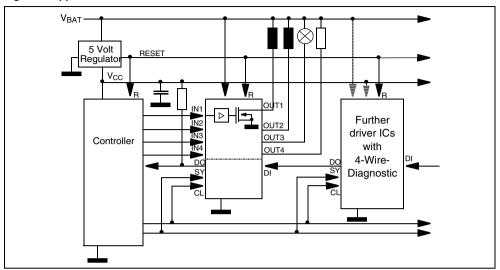


Figure 3. Output voltage TIMING for inductive load



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Figure 4. Application Circuit



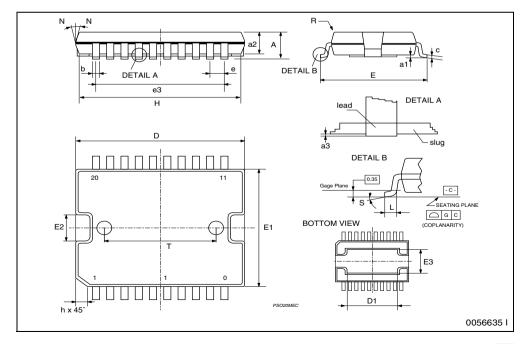
		mm			inch		
DIM.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Α			3.6			0.142	
a1	0.1		0.3	0.004		0.012	
a2			3.3			0.130	
a3	0		0.1	0.000		0.004	
b	0.4		0.53	0.016		0.021	
С	0.23		0.32	0.009		0.013	
D (1)	15.8		16	0.622		0.630	
D1 (2)	9.4		9.8	0.370		0.386	
Е	13.9		14.5	0.547		0.570	
е		1.27			0.050		
e3		11.43			0.450		
E1 (1)	10.9		11.1	0.429		0.437	
E2			2.9			0.114	
E3	5.8		6.2	0.228		0.244	
G	0		0.1	0.000		0.004	
Н	15.5		15.9	0.610		0.626	
h			1.1			0.043	
L	0.8		1.1	0.031		0.043	
N	8°(typ.)						
S			8°(m	nax.)			
Т		10			0.394		

- (1) "D and E1" do not include mold flash or protusions.
- Mold flash or protusions shall not exceed 0.15mm (0.006")
   Critical dimensions: "E", "G" and "a3".

  (2) For subcontractors, the limit is the one quoted in jedec MO-166

# **OUTLINE AND MECHANICAL DATA**





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